

11-06-1998

Docket No.: SEC.392

FORM PTO-1595 (Modified)
(Rev. 6-93)
OMB No. 0651-0011 (exp. 4/94)
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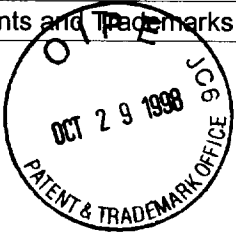
T U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

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Handwritten: 11/05 10-29-98

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.



1. Name of conveying party(ies):

Sung-kyeong KIM
Hun CHA

2. Name and address of receiving party(ies):

Name: SAMSUNG ELECTRONICS CO., LTD.

Address: 416, Maetan-dong, Paldal-gu, Suwon-city

Additional names(s) of conveying party(ies)

Yes No

3. Nature of conveyance:

Assignment

Merger

Security Agreement

Change of Name

Other

City: Kyungki-do

State/Prov.: _____

Country: Republic of Korea

ZIP: _____

Execution Date: July 18, 1998

Additional name(s) & address(es)

Yes No

4. Application number(s) or registration numbers(s):

If this document is being filed together with a new application, the execution date of the application is: _____

Patent Application No.

Filing date

B. Patent No.(s)

09/116,483

July 16, 1998

11/05/1998 SBURNS 00000072 09116483

01 FC:581

40.00 OP

Additional numbers

Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: RAYMOND C. JONES

Registration No. 34,631

Address: JONES & VOLENTINE, L.L.P.

12200 SUNRISE VALLEY DRIVE

SUITE 150

City: RESTON

State/Prov.: VA

Country: U.S.A.

ZIP: 20191

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

Enclosed - Any excess or insufficiency should be credited or debited to deposit account

Authorized to be charged to deposit account

8. Deposit account number:

50-0238

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

RAYMOND C. JONES

Name of Person Signing

Signature

OCTOBER 29, 1998

Date

Total number of pages including cover sheet, attachments, and

3

PATENT

REEL: 9555 FRAME: 0049

JONES &
VOLENTINE,
L.L.P. (1/97)

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Insert Name(s) of Inventor(s) Sung-kyeong KIM and
Hun CHA

Insert Name(s) of Assignee(s) the undersigned hereby sell(s) and assign(s) to
SAMSUNG ELECTRONICS CO., LTD.

Address of 416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea

(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

Title of Invention METHOD OF ETCHING METALLIC FILM FOR SEMICONDUCTOR DEVICES

Date of Signing of Application for which an application for patent in the United States of America has been executed by the undersigned
on

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) to Raymond C. Jones, Reg. No. 34,631 and Adam C. Volentine, Reg. No. 33,289, members of the firm of JONES & VOLENTINE, L.L.P. the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date July 18, 1998, Name of Inventor Sung-kyeong Kim
 Date July 18, 1998, Name of Inventor Cha Hun
 Date _____, Name of Inventor _____
 Date _____, Name of Inventor _____
 Date _____, Name of Inventor _____

(Note regarding Witnessing and/or Acknowledgment: Acknowledgment before a United States Consul is preferred but not required. If not acknowledged, then it is recommended that the execution by the Inventor(s) be witnessed by at least two witnesses who sign here. However, the current practice of the U.S. Patent and Trademark Office is to record an Assignment even if it has not been acknowledged and/or recorded.)

Witness Jongin Jang
 Witness Christus

ACKNOWLEDGMENT

_____ }
 _____ } ss

This _____ day of _____, 19____, before me
 personally came the above-named _____

to me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth.

 Official Signature

 Official Title

SEAL

 Applicant Reference No.: SS-9705-177-US Atty Docket No.: SEC.392
 Serial No.: _____ Filing Date: _____